

REV.	ECN NO	CONTENT	DATE	ENGINEER
A0				

1. MATERIAL:

MOLDING: LCP UL94 V-0

CONTACT: COPPER ALLOY.

PLATED GOLD ON CONTACT AREA,
G/F GOLD ON SOLDER AREA,
50u" NICKEL PLATING OVER ALL.

SHELL: SUS304-H, T=0.30±0.03mm

50u" NICKEL PLATING OVER ALL.

EMI SHILD: SUS304-H, T=0.12±0.03mm

LATCH: SUS301-H, T=0.15±0.03mm

2. MECHANICAL:

INSERTION: 5~20N.

EXTRACTION: 8~20N.

DURABILITY: 10000 CYCLES

3. ELECTRICAL:

CURRENT: 5A MAX FOR VBUS;

1.25A FOR GND, 0.25A FOR OTHER OTHER.

VOLTAGE: 20VDC MAX

WITHSTANDING VOLTAGE: 100V AC.

CONTACT RESISTANCE: 40mΩ MAX.

INSULATION RESISTANCE: 100MΩ MIN.

4. ENVIRONMENTAL

TEMPERATURE RANGE: -30° C TO +80° C

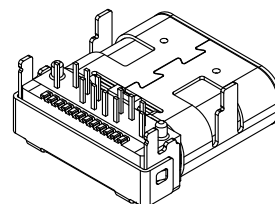
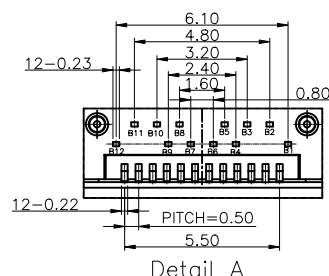
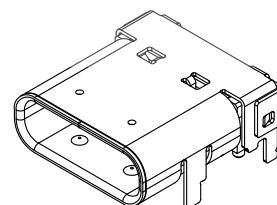
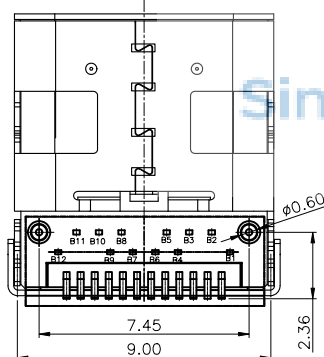
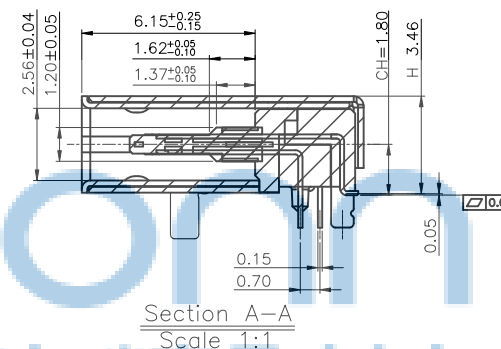
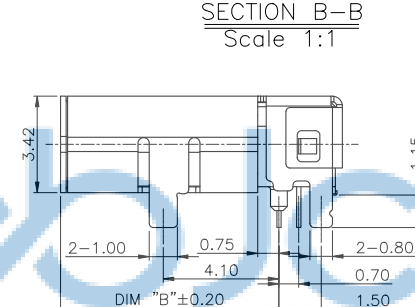
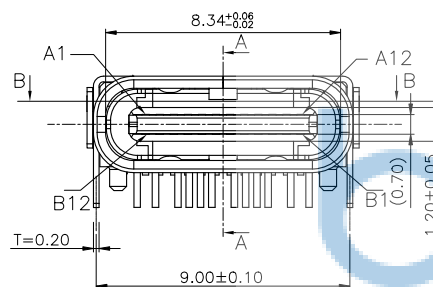
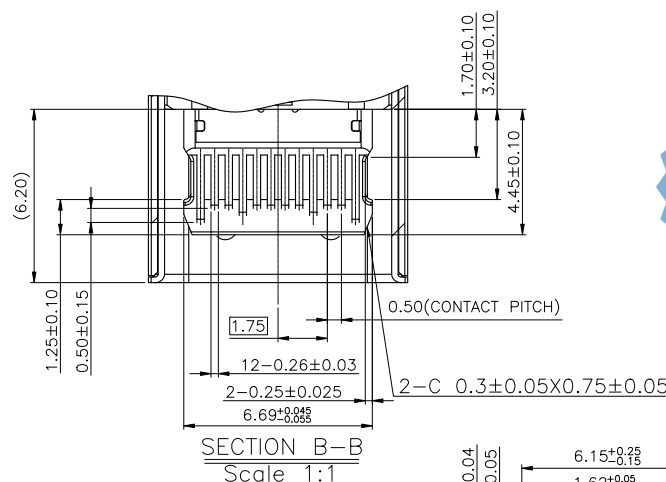
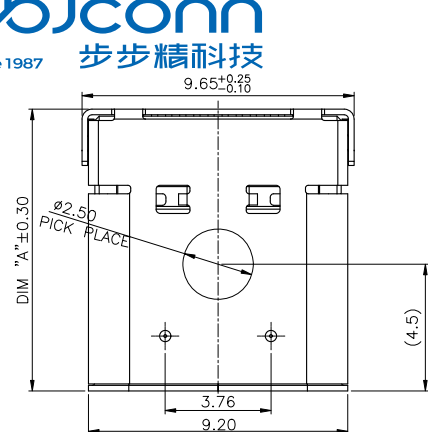


深圳市步步精科技有限公司

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PDWG,NO: 0228-1

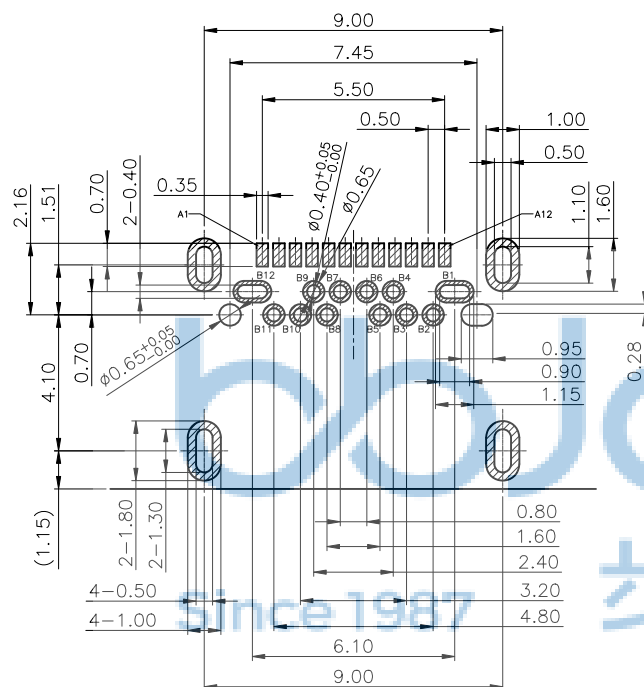
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.XX: ±0.25 .X': ±2'
.XXX: ±0.13 .X': ±1'
APPD. JM_Zheng
CHKD. TSP
DR. LYX

NAME: U4 40G速率 TYPE-C 24PIN 母座 双壳 板上四脚插
带柱 脚长1.2 端子SMT+DIP L=10.0 CH=1.80 编带
PJ. NO.: UC.01.52-1W-0013
SIZE: A4 DRW NO.:
FINISH: SEE NOTES MAT'L.: SEE NOTES
SCALE: N/A REV.: A3 UNIT: mm PAGE: 1/4



REV.	ECN NO.	CONTENT	DATE	ENGINEER
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USB TYPE-C FULL-FEATURED RECEPTACLE INTERFACE PIN ASSIGNMENTS



RECOMMEND P.C.B LAYOUT (COMPONENT SIDE)

TOLERANCE FOR PCB LAYOUT IS ± 0.05

PIN	Signal Name	Description	PIN	Signal Name	Description
A1	GND	Ground return	B12	GND	Ground return
A2	SSTXp1	Positive half of first SuperSpeed TX differential pair	B11	SSRXp1	Positive half of first SuperSpeed RX differential pair
A3	SSTXn1	Negative half of first SuperSpeed TX differential pair	B10	SSRXn1	Negative half of first SuperSpeed RX differential pair
A4	VBUS	Bus Power	B9	VBUS	Bus Power
A5	CC1	Configuration Channel	B8	SBU2	Sideband Use (SBU)
A6	Dp1	Positive half of the USB 2.0 differential pair-Position 1	B7	Dn2	Negative half of the USB 2.0 differential pair-Position 2
A7	Dn1	Negative half of the USB 2.0 differential pair-Position 1	B6	Dp2	Positive half of the USB 2.0 differential pair-Position 2
A8	SBU1	Sideband Use (SBU)	B5	CC2	Configuraation Channel
A9	VBUS	Bus Power	B4	VBUS	Bus Power
A10	SSRXn2	Negative half of second SuperSpeed RX differential pair	B3	SSTXn2	Negative half of second SuperSpeed TX differential pair
A11	SSRXp2	Positive half of second SuperSpeed RX differential pair	B2	SSTXp2	Positive half of second SuperSpeed TX differential pair
A12	GND	Ground return	B1	GND	Ground return

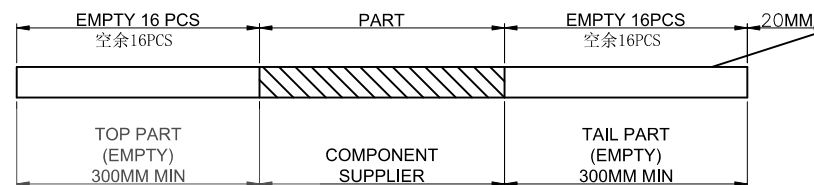
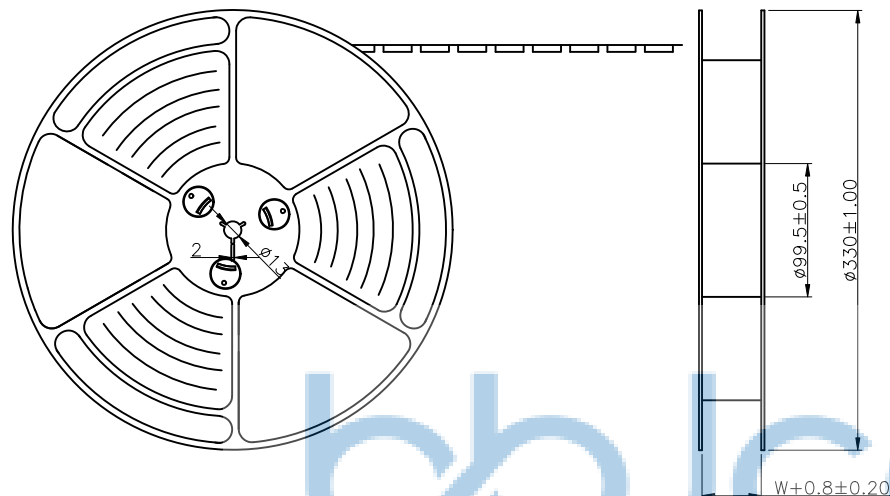


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APPD. JM_Zheng		NAME: U4 40G速率 TYPE-C 24PIN 母座 双壳 板上四脚插 带柱 脚长1.2 端子SMT+DIP L=10.0 CH=1.80 编带	
CHKD. TSP		PJ. NO.: UC.01.52-1W-0013 SIZE: A4 DRW NO.:	
PDWG.NO: 0228-1		FINISH: SEE NOTES MAT'L.: SEE NOTES SCALE: N/A REV.: A3 UNIT: mm PAGE: 2/4	
DR. LYX			

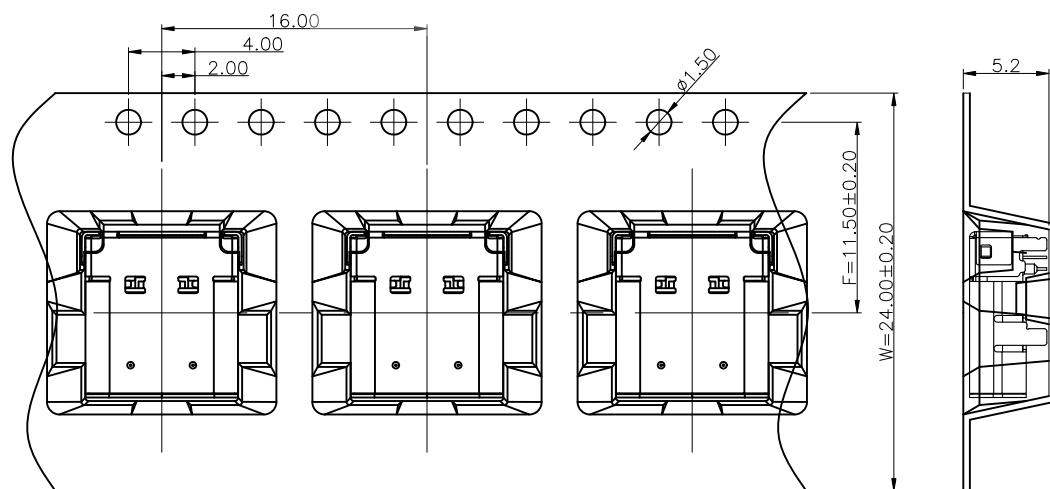
出料方向
PULL OUT DIRECTEON

NOTES

- 1.帶子引導長度
LEAD TAPE LENGTH
出料方向
PULL OUT DIRECTEON



- 2.出貨運輸過程中一定注意：
THIS REQUIREMENT SHOULD BE APPLIED AT SHIPMENT：
卷帶在運輸過程中不能散開
PEELING OFF SHOULD NOT BE ALLOWED DURING TRANSPORTATION

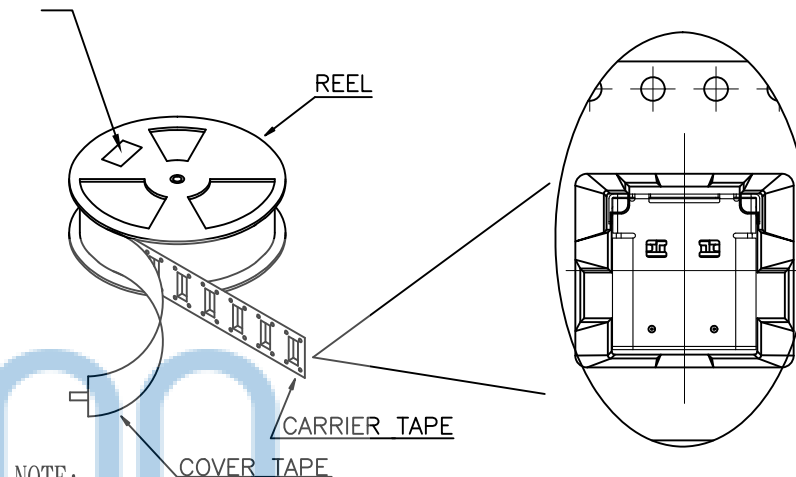
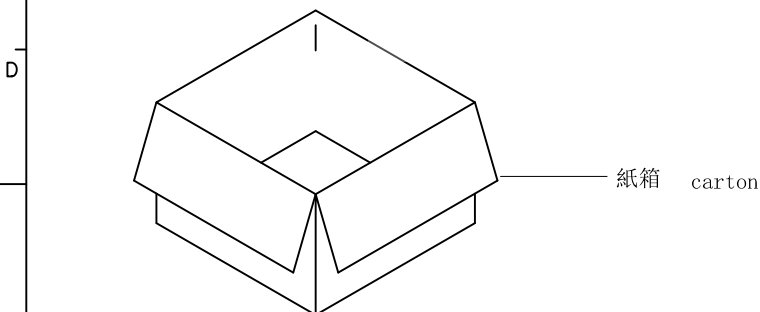
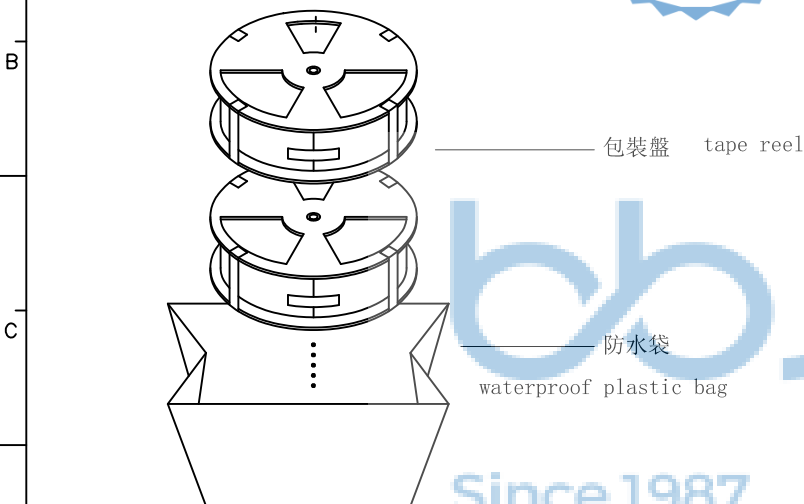


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PDWG.NO: 0228-1	DR. LYX	SCALE: N/A REV.: A3 UNIT: mm PAGE: 3/4	



at small positioning hole of the carrier tape side).
標籤黏貼處 (朝捲裝包材的小定位孔一側)

Location of label sticking (label



NOTE:

1. 每捲包裝數量及每箱裝箱數量如左下表格。
Packing q'ty of each reel & carton as below table shown.
2. 以上膠帶覆蓋下包裝帶經包裝機熱熔包裝
Use cover tape to cover and hot melt machine to seal up.
3. 將裝滿產品的卷盤放入紙箱并以膠帶封口
Put reels in the carton and use adhesive tape to seal up.

包裝容量 (PACKING CAPACITY)			重量 WEIGHT (Kg)		
PCS/REEL	REELS/CARTON	PCS/CARTON	N.W./PCS	N.W./BOX	G.W./BOX
800	10	8000	0.704		

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